



Customer Information Notification

202010024I

Issue Date: 08-Nov-2020

Effective Date: 09-Nov-2020

Dear *Emma Tempest*,

Here's your personalized quality information concerning products Premier Farnell PLC purchased from NXP.

For detailed information we invite you to [view this notification online](#)

This notice is NXP Company Proprietary.



QUALITY

Change Category

- | | | | | |
|----------------------------------------------|---------------------------------------------|----------------------------------------------------|-----------------------------------------|---------------------------------------------------------|
| <input type="checkbox"/> Wafer Fab Process | <input type="checkbox"/> Assembly Process | <input type="checkbox"/> Product Marking | <input type="checkbox"/> Test Location | <input type="checkbox"/> Design |
| <input type="checkbox"/> Wafer Fab Materials | <input type="checkbox"/> Assembly Materials | <input type="checkbox"/> Mechanical Specification | <input type="checkbox"/> Test Process | <input checked="" type="checkbox"/> Errata |
| <input type="checkbox"/> Wafer Fab Location | <input type="checkbox"/> Assembly Location | <input type="checkbox"/> Packing/Shipping/Labeling | <input type="checkbox"/> Test Equipment | <input type="checkbox"/> Electrical spec./Test coverage |
| <input type="checkbox"/> Firmware | <input type="checkbox"/> Other | | | |

i.MXRT1060/i.MXRT1064 Chip Errata Rev 1.2 Update for 0N00X and Release Errata Rev1.0 for 1N00X

Description

NXP Semiconductors announces chip errata update to revision 1.2 for i.MXRT1060 and i.MXRT1064 silicon A and release revision 1.0 for i.MXRT1060 and i.MXRT1064 silicon B. The revision history included in the updated documents provides a detailed description of the changes. Changes are summarized below.

For RT1060/RT1064 Silicon A Chip Errata:

Added following 3 errata:

- * ERR050469: SEMC: 8/16bit write to 8bit PSRAM might cause data corruption
- * ERR050164: BEE: Unaligned access may cause bus error
- * ERR050538: SOC: Potential boot failure on system reset if SJC_DISABLE fuse is blown

Release separate Chip Errata Document for RT1060 Silicon B with removing following errata:

- * ERR050101: USB: Endpoint conflict issue in device mode
- * ERR006032: FlexCAN: A frame with wrong ID or payload is transmitted into the CAN bus when the Message Buffer under transmission is either aborted or deactivated while the CAN bus is in the Bus Idle state

Release separate Chip Errata Document for RT1064 Silicon B with removing following errata:

- * ERR050101: USB: Endpoint conflict issue in device mode

The i.MXRT1060 errata is attached to this notice, and can be found at:
https://www.nxp.com/products/processors-and-microcontrollers/arm-microcontrollers/i.mx-rt-series/i.mx-rt1060-crossover-processor-with-arm-cortex-m7-core:i.MX-RT1060?tab=Documentation_Tab&linkline=Errata

The i.MXRT1064 errata is attached to this notice, and can be found at:
https://www.nxp.com/products/processors-and-microcontrollers/arm-microcontrollers/i.mx-rt-series/i.mx-rt1064-crossover-processor-with-arm-cortex-m7-core:i.MX-RT1064?tab=Documentation_Tab&linkline=Errata

Reason

The errata was added or removed for additional technical clarification on some device features.

Identification of Affected Products

Product identification does not change

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No impact on form, fit, function, reliability or quality.

Additional information

Affected products and sales history information: see attached file

Additional documents: [view online](#)



Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please [contact NXP "Global Quality Support Team"](#).

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name technical support
e-mail address tech.support@nxp.com

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

Customer Focus, Passion to Win.

NXP Quality Management Team.

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NXP Semiconductors
High Tech Campus, 5656 AG Eindhoven, The Netherlands

